

MM3Z2V2B~MM3Z39B

Silicon Planar Zener Diodes

Features

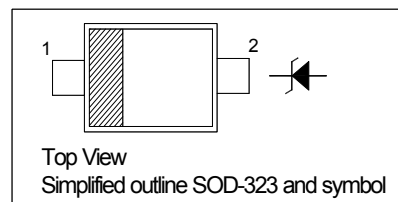
- Total power dissipation: max. 300 mW
- Small plastic package suitable for surface mounted design
- High reliability

Description

Silicon planar Zener diode in a small plastic SMD SOD-323 package

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



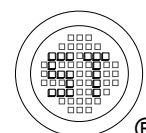
Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Value	Unit
Power Dissipation	P_{tot}	300	mW
Junction Temperature	T_j	150	$^\circ\text{C}$
Storage Temperature Range	T_{Stg}	- 55 to + 150	$^\circ\text{C}$

Characteristics at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Max.	Unit
Thermal Resistance Junction to Ambient Air ¹⁾	R_{thA}	417	$^\circ\text{C/W}$

¹⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



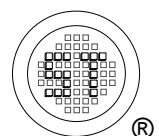
MM3Z2V2B~MM3Z39B

Characteristics at $T_a = 25^\circ\text{C}$ ($V_F = 0.9\text{ V Max. at } I_F = 10\text{ mA}$)

Type	Marking Code	Zener Voltage Range ¹⁾			Dynamic Impedance ²⁾		Reverse Leakage Current	
		V_{ZT}		I_{ZT}	$Z_{ZT}(\text{Max.})$	at I_{ZT}	$I_R(\text{Max.})$	at V_R
		Min.(V)	Max.(V)	mA	Ω	mA	μA	V
MM3Z2V2B	MF	2.1	2.4	5	100	5	120	0.7
MM3Z2V4B	7C	2.3	2.65	5	100	5	120	1
MM3Z2V7B	7D	2.65	2.95	5	110	5	120	1
MM3Z3V0B	7E	2.95	3.25	5	120	5	50	1
MM3Z3V3B	7F	3.25	3.55	5	120	5	20	1
MM3Z3V6B	7H	3.6	3.845	5	100	5	10	1
MM3Z3V9B	7J	3.89	4.16	5	100	5	5	1
MM3Z4V3B	7K	4.17	4.43	5	100	5	5	1
MM3Z4V7B	7M	4.55	4.75	5	100	5	2	1
MM3Z5V1B	7N	4.98	5.2	5	80	5	2	1.5
MM3Z5V6B	7P	5.49	5.73	5	60	5	1	2.5
MM3Z6V2B	7R	6.06	6.33	5	60	5	1	3
MM3Z6V8B	7X	6.65	6.93	5	40	5	0.5	3.5
MM3Z7V5B	7Y	7.28	7.6	5	30	5	0.5	4
MM3Z8V2B	7Z	8.02	8.36	5	30	5	0.5	5
MM3Z9V1B	8A	8.85	9.23	5	30	5	0.5	6
MM3Z10B	8B	9.77	10.21	5	30	5	0.1	7
MM3Z11B	8C	10.76	11.22	5	30	5	0.1	8
MM3Z12B	8D	11.74	12.24	5	30	5	0.1	9
MM3Z13B	8E	12.91	13.49	5	37	5	0.1	10
MM3Z15B	8F	14.34	14.98	5	42	5	0.1	11
MM3Z16B	8H	15.85	16.51	5	50	5	0.1	12
MM3Z18B	8J	17.56	18.35	5	65	5	0.1	13
MM3Z20B	8K	19.52	20.39	5	85	5	0.1	15
MM3Z22B	8M	21.54	22.47	5	100	5	0.1	17
MM3Z24B	8N	23.72	24.78	5	120	5	0.1	19
MM3Z27B	8P	26.19	27.53	5	150	5	0.1	21
MM3Z30B	8R	29.19	30.69	5	200	5	0.1	23
MM3Z33B	8X	32.15	33.79	5	250	5	0.1	25
MM3Z36B	8Y	35.07	36.87	5	300	5	0.1	27
MM3Z39B	8Z	37	41	5	100	5	2	30

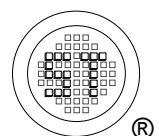
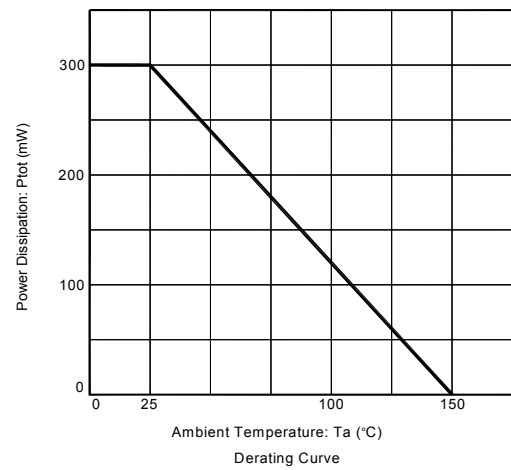
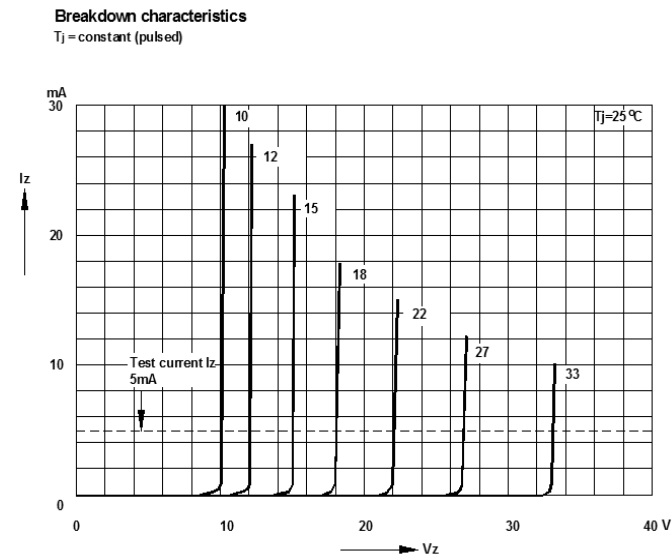
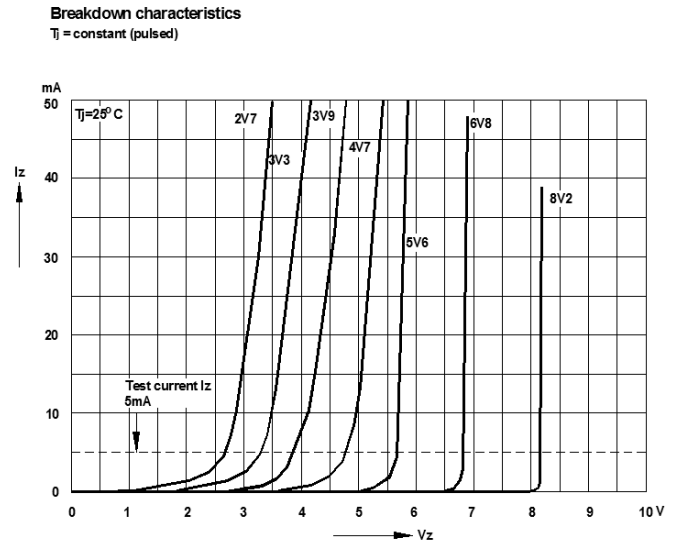
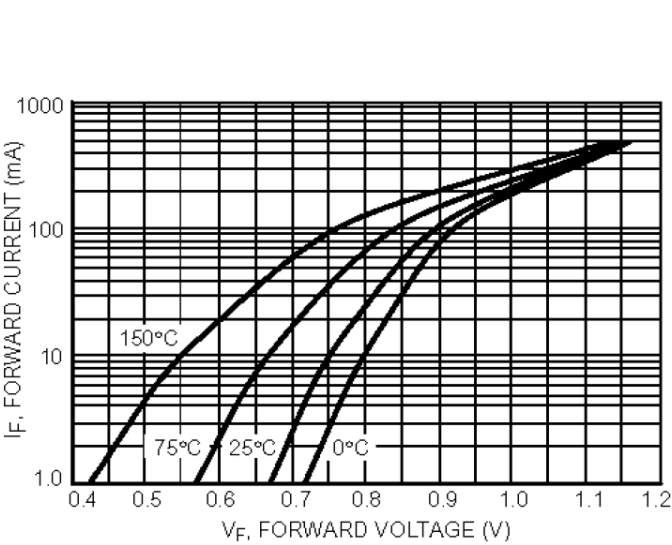
¹⁾ V_Z is tested with pulses (20 ms).

²⁾ Z_{ZT} is measured at I_Z by given a very small A.C. current signal.



MM3Z2V2B~MM3Z39B

Electrical Characteristics Curves

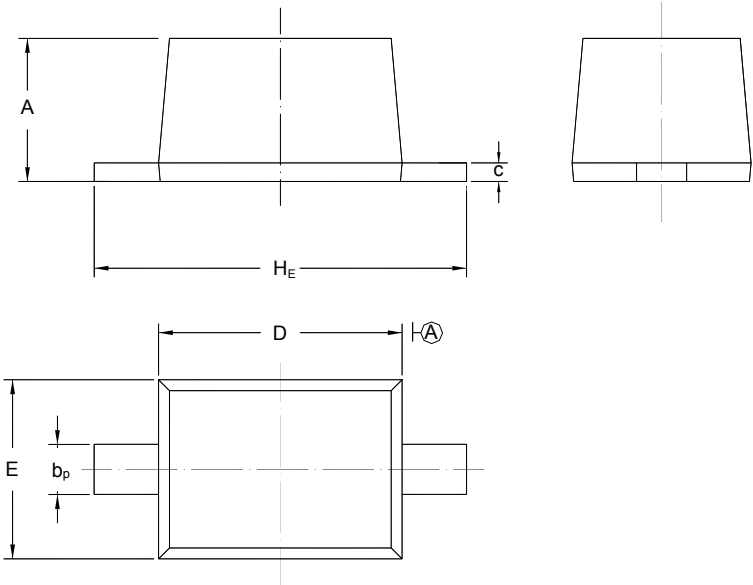


MM3Z2V2B~MM3Z39B

PACKAGE OUTLINE

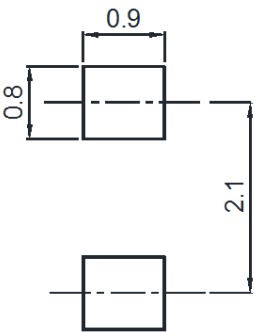
Plastic surface mounted package; 2 leads

SOD-323



UNIT	A	b _p	C	D	E	H _E
mm	1.10 0.80	0.40 0.25	0.15 0.10	1.80 1.60	1.35 1.15	2.80 2.30

Recommended Soldering Footprint



Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
SOD-323	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000

Marking information

" III " = Cathode line

" ** " = Part No.

Font type: Arial

